Electronic Acknowledgement Receipt				
EFS ID: 1127352				
Application Number:	10711503			
Confirmation Number:	5502			
Title of Invention:	IC PACKAGE HAVING GROUND IC CHIP AND METHOD OF MANUFACTURING SAME			
First Named Inventor:	PEI-HAW TSAO			
Customer Number:	44045			
Filer:	James H. Ortega			
Filer Authorized By:				
Attorney Docket Number:	TSMC 2003-1622			
Receipt Date:	26-JUL-2006			
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Application Type:	Utility			
International Application Number:				
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Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		TSMC2003-1622Responseto FinalOA.pdf	139707	yes	8

	Multipart Description				
	Doc Desc	Start	End		
	Amendment After Final	1	1		
	Claims	2	4		
	Applicant Arguments/Remarks Made in an Amendment	5	8		
Warnings:					
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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.